

# APHF1608SEEQBDZGKC

1.6 x 0.8 mm Full-Color Surface Mount LED



## **DESCRIPTIONS**

- The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode
- The Blue source color devices are made with InGaN Light Emitting Diode
- The Green source color devices are made with InGaN on Sapphire Light Emitting Diode
- · Electrostatic discharge and power surge could damage the LEDs
- . It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- · All devices, equipments and machineries must be electrically grounded

## **FEATURES**

- 1.6 x 0.8 mm SMD LED, 0.5 mm thickness
- · Low power consumption
- Package in 8mm tape on 7" diameter reel, 4000 pcs / reel
- · Can produce any color in visible spectrum, including white light
- Moisture sensitivity level: 3
- Halogen-free
- RoHS compliant

## **APPLICATIONS**

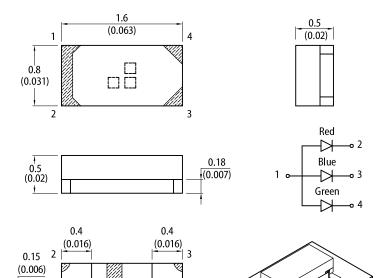
- Backlight
- · Status indicator
- Home and smart appliances
- · Wearable and portable devices
- Healthcare applications

## **ATTENTION**

Observe precautions for handling electrostatic discharge sensitive devices

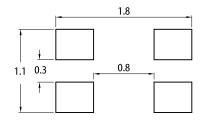


## **PACKAGE DIMENSIONS**



## **RECOMMENDED SOLDERING PATTERN**

(units: mm; tolerance: ± 0.1)



- Toles.

  1. All dimensions are in millimeters (inches).

  2. Tolerance is ±0.15(0.006") unless otherwise noted.

  3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
- The device has a single mounting surface. The device must be mounted according to the specifications

## **SELECTION GUIDE**

Part Number	Emitting Color (Material)	Lens Type	Iv (mcd) @ 20mA [2]		Viewing Angle [1]
			Min.	Тур.	201/2
APHF1608SEEQBDZGKC	■ Hyper Red (AlGaInP)	Water Clear	40	120	140°
	■ Blue (InGaN)		20	60	
	Green (InGaN)		200	480	

Notes.
1. 61/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
2. Luminous intensity / luminous flux: +/-15%.

3. Luminous intensity value is traceable to CIE127-2007 standards.





# **ELECTRICAL / OPTICAL CHARACTERISTICS at T<sub>A</sub>=25°C**

Domenton	Comple of	O. l	Value			
Parameter	Symbol	Emitting Color	Тур.	Max. Uni		
		Hyper Red	630			
Wavelength at Peak Emission I <sub>F</sub> = 20mA	$\lambda_{peak}$	Blue	460	-	nm	
		Green	515			
		Hyper Red	621			
Dominant Wavelength I <sub>F</sub> = 20mA	$\lambda_{dom}$ [1]	Blue	465	-	nm	
		Green	525			
Spectral Bandwidth at 50% Φ REL MAX		Hyper Red	20			
I <sub>F</sub> = 20mA	Δλ	Blue	25	-	nm	
I <sub>F</sub> - 2011IA		Green	35			
		Hyper Red	25			
Capacitance	С	Blue	100	-	pF	
		Green	45			
		Hyper Red	2	2.5		
Forward Voltage I <sub>F</sub> = 20mA	V <sub>F</sub> <sup>[2]</sup>	Blue	3.3	4.0	V	
•		Green	3.3	4.1		
		Hyper Red		10		
Reverse Current (V <sub>R</sub> = 5V)	I <sub>R</sub>	Blue	-	50	μA	
, ,		Green		50	·	
Townsendure Coefficient of )		Hyper Red	0.13			
Temperature Coefficient of λ <sub>peak</sub>	TC <sub>λpeak</sub>	Blue	0.04	-	nm/°C	
$I_F$ = 20mA, -10°C $\leq$ T $\leq$ 85°C	.,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	Green	0.05			
Townserstone Coefficient of )		Hyper Red	0.06			
Temperature Coefficient of λ <sub>dom</sub>	$TC_{\lambdadom}$	Blue	0.03	-	nm/°C	
$I_F$ = 20mA, -10°C $\leq$ T $\leq$ 85°C		Green	0.03			
T-man and the O-efficient of M		Hyper Red	-1.9			
Temperature Coefficient of V <sub>F</sub>	TC <sub>V</sub>	Blue	-2.9	-	mV/°C	
$I_F$ = 20mA, -10°C $\leq$ T $\leq$ 85°C		Green	-2.9			

#### Notes:

- Nules.

  1. The dominant wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd:±1nm.)

  2. Forward voltage: ±0.1V.

  3. Wavelength value is traceable to CIE127-2007 standards.

  4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

# ABSOLUTE MAXIMUM RATINGS at T<sub>A</sub>=25°C

Parameter	Symbol	Value			Unit
r arameter		Hyper Red	Blue	Green	Oillt
Power Dissipation	$P_D$	75	80	82	mW
Reverse Voltage	V <sub>R</sub>	5	5	5	V
Junction Temperature	T <sub>j</sub>	115	115	115	°C
Operating Temperature	T <sub>op</sub>		°C		
Storage Temperature	$T_{stg}$	-40 to +85			°C
DC Forward Current	I <sub>F</sub>	30	20	20	mA
Peak Forward Current	I <sub>FM</sub> <sup>[1]</sup>	195	100	100	mA
Electrostatic Discharge Threshold (HBM)	-	3000	250	450	V
Thermal Resistance (Junction / Ambient)	R <sub>th JA</sub> <sup>[2]</sup>	730	720	700	°C/W
Thermal Resistance (Junction / Solder point)	R <sub>th JS</sub> <sup>[2]</sup>	610	620	590	°C/W

- Tules.

  1. 1/10 Duty Cycle, 0.1ms Pulse Width.

  2. R<sub>th JA</sub>, R<sub>th JS</sub> Results from mounting on PC board FR4 (pad size ≥ 16 mm² per pad).

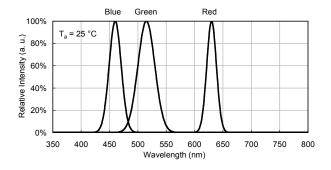
  3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity Ref JEDEC/JESD625-A and JEDEC/J-STD-033.



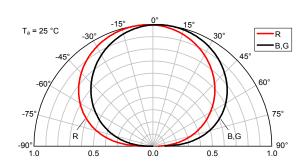


## **TECHNICAL DATA**

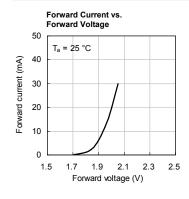
## **RELATIVE INTENSITY vs. WAVELENGTH**

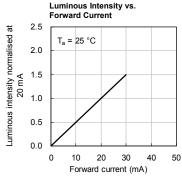


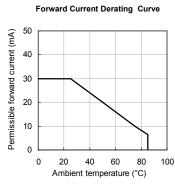
### **SPATIAL DISTRIBUTION**

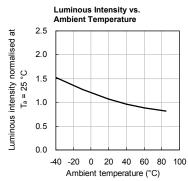


## **HYPER RED**

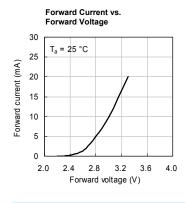


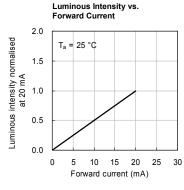


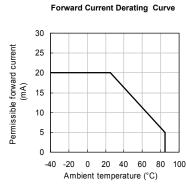


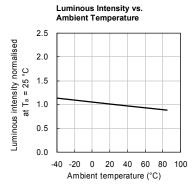


## **BLUE**

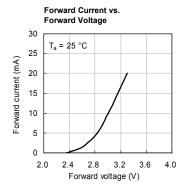


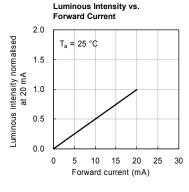


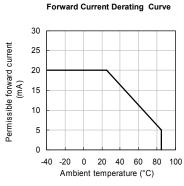


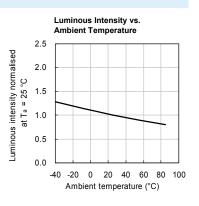


## **GREEN**











### **REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS**

#### 300 above 255℃ (°C) 260°C max. 30s max. 250 10s max. 3°C/s max 6°C/s max. 200 150 Temperature pre-heating 100 150~200°C above 217°C 60~120s 60~150s 50 25°C 0 50 100 150 200 250 300 (sec) Time

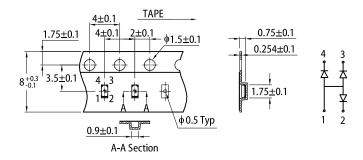
- Notes:

  1. Don't cause stress to the LEDs while it is exposed to high temperature.

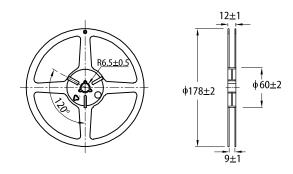
  2. The maximum number of reflow soldering passes is 2 times.

  3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

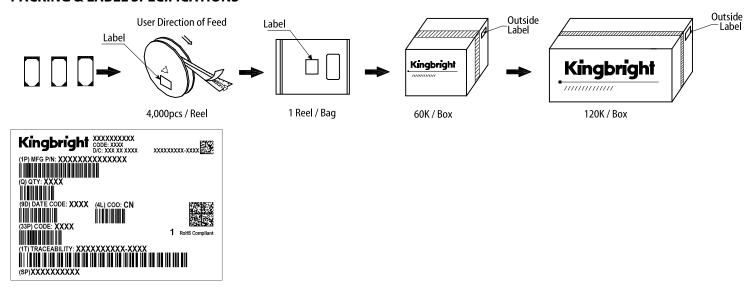
## TAPE SPECIFICATIONS (units:mm)



## **REEL DIMENSION** (units: mm)



## PACKING & LABEL SPECIFICATIONS



### **PRECAUTIONARY NOTES**

- The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to
- the latest datasheet for the updated specifications.

  When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If
- toustomer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.

  The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening liabilities, such as automotive or medical usage, please consult with Kingbright representative for further assistance.
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